

74VCX86

Low Voltage Quad 2-Input Exclusive-OR Gate with 3.6V Tolerant Inputs and Outputs

General Description

The VCX86 contains four 2-input exclusive OR gates. This product is designed for low voltage (1.2V to 3.6V) V_{CC} applications with I/O compatibility up to 3.6V

The 74VCX86 is fabricated with an advanced CMOS technology to achieve high-speed operation while maintaining low CMOS power dissipation.

Features

- 1.2V to 3.6V V_{CC} supply operation
- 3.6V tolerant inputs and outputs
- t_{PD}
3.0 ns max for 3.0V to 3.6V V_{CC}
- Power-off high impedance inputs and outputs
- Static Drive (I_{OH}/I_{OL})
 ± 24 mA @ 3.0V V_{CC}
- Uses proprietary noise/EMI reduction circuit
- Latchup performance exceeds JEDEC 78 conditions
- ESD performance:
Human body model > 2000V
Machine model > 250V
- Leadless Pb-Free DQFN package

Ordering Code:

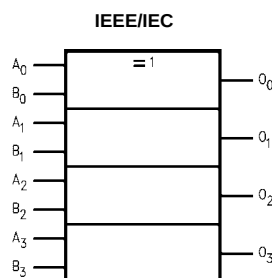
Order Number	Package Number	Package Description
74VCX86M	M14A	14-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150" Narrow
74VCX86BQX (Note 1)	MLP014A	Pb-Free 14-Terminal Depopulated Quad Very-Thin Flat Pack No Leads (DQFN), JEDEC MO-241, 2.5 x 3.0mm
74VCX86MTC	MTC14	14-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.
Pb-Free package per JEDEC J-STD-020B.

Note 1: DQFN package available in Tape and Reel only.

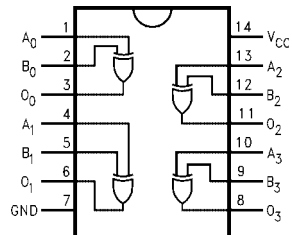
74VCX86 Low Voltage Quad 2-Input Exclusive-OR Gate with 3.6V Tolerant Inputs and Outputs

Logic Symbol



Connection Diagrams

Pin Assignments for SOIC and TSSOP

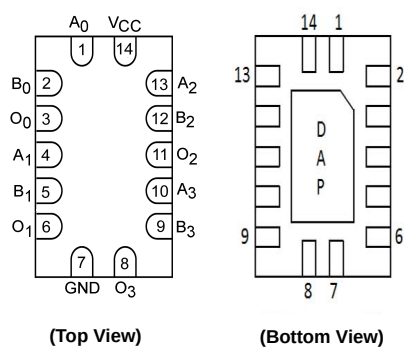


Pin Descriptions

Pin Names	Description
A_n, B_n	Inputs
O_n	Outputs
DAP	No Connect

Note: DAP (Die Attach Pad)

Pad Assignments for DQFN



Absolute Maximum Ratings(Note 2)

Supply Voltage (V_{CC})	-0.5V to +4.6V
DC Input Voltage (V_I)	-0.5V to +4.6V
Output Voltage (V_O)	
HIGH or LOW State (Note 3)	-0.5V to V_{CC} +0.5V
$V_{CC} = 0V$	-0.5V to +4.6V
DC Input Diode Current (I_{IK}) $V_I < 0V$	-50 mA
DC Output Diode Current (I_{OK})	
$V_O < 0V$	-50 mA
$V_O > V_{CC}$	+50 mA
DC Output Source/Sink Current (I_{OH}/I_{OL})	±50 mA
DC V_{CC} or GND Current per Supply Pin (I_{CC} or Ground)	±100 mA
Storage Temperature Range (T_{STG})	-65°C to +150°C

Recommended Operating Conditions (Note 4)

Power Supply	
Operating	1.2V to 3.6V
Input Voltage	-0.3V to +3.6V
Output Voltage (V_O)	
HIGH or LOW State	0V to V_{CC}
Output Current in I_{OH}/I_{OL}	
$V_{CC} = 3.0V$ to 3.6V	±24 mA
$V_{CC} = 2.3V$ to 2.7V	±18 mA
$V_{CC} = 1.65V$ to 2.3V	±6 mA
$V_{CC} = 1.4V$ to 1.6V	±2 mA
$V_{CC} = 1.2V$	±100 μA
Free Air Operating Temperature (T_A)	-40°C to +85°C
Minimum Input Edge Rate ($\Delta t/\Delta V$)	
$V_{IN} = 0.8V$ to 2.0V, $V_{CC} = 3.0V$	10 ns/V

Note 2: The Absolute Maximum Ratings are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the Absolute Maximum Ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 3: I_O Absolute Maximum Rating must be observed.

Note 4: Floating or unused inputs must be held HIGH or LOW.

DC Electrical Characteristics

Symbol	Parameter	Conditions	V_{CC} (V)	Min	Max	Units
V_{IH}	HIGH Level Input Voltage		2.7 - 3.6 2.3 - 2.7 1.65 - 2.3 1.4 - 1.6 1.2	2.0 1.6 $0.65 \times V_{CC}$ $0.65 \times V_{CC}$ $0.65 \times V_{CC}$		V
V_{IL}	LOW Level Input Voltage		2.7 - 3.6 2.3 - 2.7 1.65 - 2.3 1.4 - 1.6 1.2		0.8 0.7 $0.35 \times V_{CC}$ $0.35 \times V_{CC}$	V
V_{OH}	HIGH Level Output Voltage	$I_{OH} = -100 \mu A$ $I_{OH} = -12 \text{ mA}$ $I_{OH} = -18 \text{ mA}$ $I_{OH} = -24 \text{ mA}$	2.7 - 3.6 2.7 3.0 3.0	$V_{CC} - 0.2$ 2.2 2.4 2.2		V
		$I_{OH} = -100 \mu A$ $I_{OH} = -6 \text{ mA}$ $I_{OH} = -12 \text{ mA}$ $I_{OH} = -18 \text{ mA}$	2.3 - 2.7 2.3 2.3 2.3	$V_{CC} - 0.2$ 2.0 1.8 1.7		
		$I_{OH} = -100 \mu A$ $I_{OH} = -6 \text{ mA}$	1.65 - 2.3 1.65	$V_{CC} - 0.2$ 1.25		
		$I_{OH} = -100 \mu A$ $I_{OH} = -2 \text{ mA}$	1.4 - 1.6 1.4	$V_{CC} - 0.2$ 1.05		
		$I_{OH} = -100 \mu A$	1.2	$V_{CC} - 0.2$		

DC Electrical Characteristics (Continued)

Symbol	Parameter	Conditions	V _{CC} (V)	Min	Max	Units
V _{OL}	LOW Level Output Voltage	I _{OL} = 100 μ A	2.7 - 3.6		0.2	V
		I _{OL} = 12 mA	2.7		0.4	
		I _{OL} = 18 mA	3.0		0.4	
		I _{OL} = 24 mA	3.0		0.55	
		I _{OL} = 100 μ A	2.3 - 2.7		0.2	
		I _{OL} = 12 mA	2.3		0.4	
		I _{OL} = 18 mA	2.3		0.6	
		I _{OL} = 100 μ A	1.65 - 2.3		0.2	
		I _{OL} = 6 mA	1.65		0.3	
		I _{OL} = 100 μ A	1.4 - 1.6		0.2	
		I _{OL} = 2 mA	1.4		0.35	
		I _{OL} = 100 μ A	1.2		0.05	
I _I	Input Leakage Current	0 $\leq$ V _I $\leq$ 3.6V	1.2 - 3.6		$\pm$ 5.0	μ A
I _{OFF}	Power-OFF Leakage Current	0 $\leq$ (V _I , V _O) $\leq$ 3.6V	0		10	μ A
I _{CC}	Quiescent Supply Current	V _I = V _{CC} or GND V _{CC} $\leq$ (V _I)	1.2 - 3.6 1.2 - 3.6		20 $\pm$ 20	μ A
Δ I _{CC}	Increase in I _{CC} per Input	V _{IH} = V _{CC} - 0.6V	2.7 - 3.6		750	μ A

AC Electrical Characteristics (Note 5)

Symbol	Parameter	Conditions	V _{CC} (V)	T _A = −40°C to +85°C		Units	Figure Number
				Min	Max		
t _{PHL} t _{PLH}	Propagation Delay	C _L = 30 pF, R _L = 500Ω	3.3 ± 0.3	0.6	3.0	ns	Figures 1, 2
			2.5 ± 0.2	0.8	3.9		
			1.8 ± 0.15	1.0	7.8		
		C _L = 15 pF, R _L = 2kΩ	1.5 ± 0.1	1.0	15.6		Figures 3, 4
			1.2	1.5	39		
t _{OSHL} t _{OSLH}	Output to Output Skew (Note 6)	C _L = 30 pF, R _L = 500Ω	3.3 ± 0.3		0.5	ns	
			2.5 ± 0.2		0.5		
			1.8 ± 0.15		0.75		
		C _L = 15 pF, R _L = 2kΩ	1.5 ± 0.1		1.5		
			1.2		1.5		

Note 5: For C_L = 50 pF, add approximately 300 ps to the AC maximum specification.

Note 6: Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t_{OSHL}) or LOW-to-HIGH (t_{OSLH}).

Dynamic Switching Characteristics

Symbol	Parameter	Conditions	V _{CC} (V)	T _A = +25°C	Units
				Typical	
V _{OLP}	Quiet Output Dynamic Peak V _{OL}	C _L = 30 pF, V _{IH} = V _{CC} , V _{IL} = 0V	1.8 2.5 3.3	0.25 0.6 0.8	V
V _{OLV}	Quiet Output Dynamic Valley V _{OL}	C _L = 30 pF, V _{IH} = V _{CC} , V _{IL} = 0V	1.8 2.5 3.3	-0.25 -0.6 -0.8	V
V _{OHV}	Quiet Output Dynamic Valley V _{OH}	C _L = 30 pF, V _{IH} = V _{CC} , V _{IL} = 0V	1.8 2.5 3.3	1.5 1.9 2.2	V

Capacitance

Symbol	Parameter	Conditions	T _A = +25°C	Units
			Typical	
C _{IN}	Input Capacitance	V _{CC} = 1.8, 2.5V or 3.3V, V _I = 0V or V _{CC}	6	pF
C _{OUT}	Output Capacitance	V _I = 0V or V _{CC} , V _{CC} = 1.8V, 2.5V or 3.3V	7	pF
C _{PD}	Power Dissipation Capacitance	V _I = 0V or V _{CC} , f = 10 MHz, V _{CC} = 1.8V, 2.5V or 3.3V	20	pF

AC Loading and Waveforms (V_{CC} 3.3V ± 0.3V to 1.8V ± 0.15V)

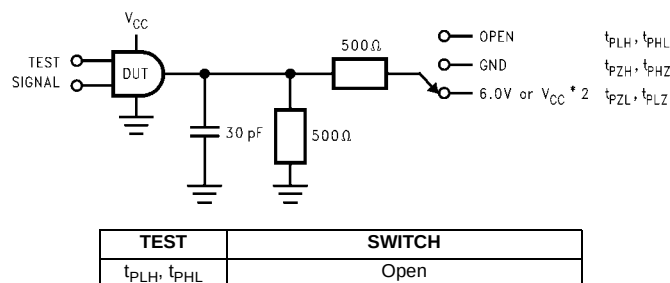


FIGURE 1. AC Test Circuit

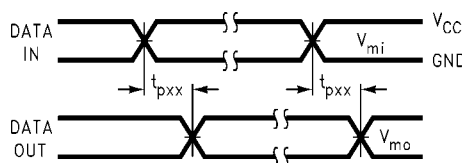
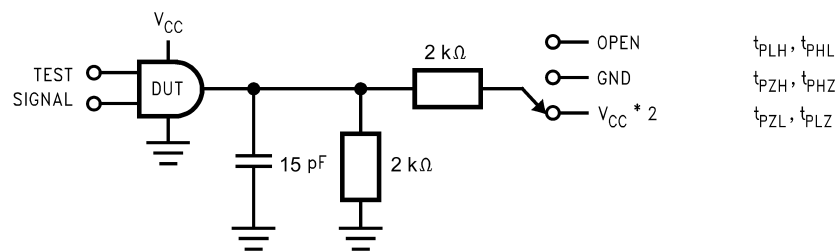


FIGURE 2. Waveform for Inverting and Non-Inverting Functions

Symbol	V _{CC}		
	3.3V ± 0.3V	2.5V ± 0.2V	1.8V ± 0.15V
V _{mi}	1.5V	V _{CC} /2	V _{CC} /2
V _{mo}	1.5V	V _{CC} /2	V _{CC} /2

AC Loading and Waveforms ($V_{CC} 1.5V \pm 0.1V$ to $1.2V$)



TEST	SWITCH
t_{PLH}, t_{PHL}	Open
t_{PZL}, t_{PLZ}	$V_{CC} \times 2$ at $V_{CC} = 1.5 \pm 0.1V$
t_{PZH}, t_{PHZ}	GND

FIGURE 3. AC Test Circuit

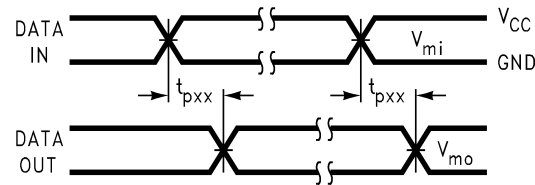


FIGURE 4. Waveform for Inverting and Non-Inverting Functions

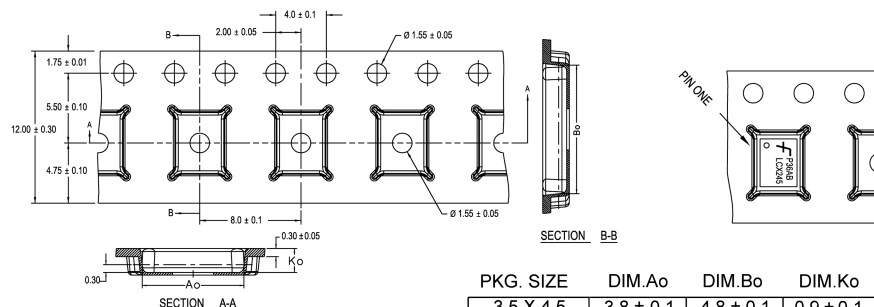
Symbol	V_{CC}
	$1.5V \pm 0.1V$
V_{mi}	$V_{CC}/2$
V_{mo}	$V_{CC}/2$

Tape and Reel Specification

Tape Format for DQFN

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
BQX	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	2500/3000	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

TAPE DIMENSIONS inches (millimeters)



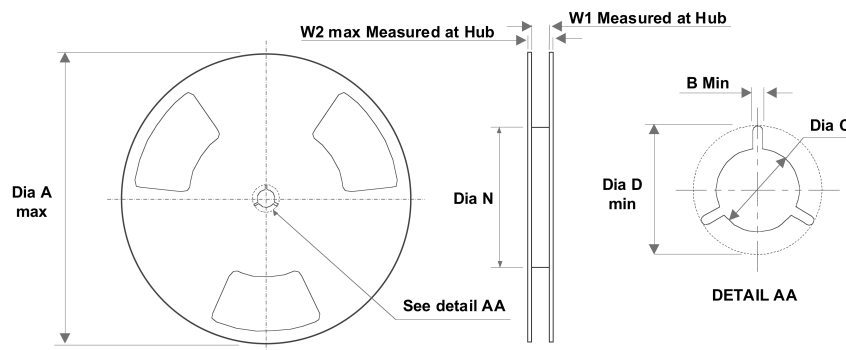
PKG. SIZE	DIM.Ao	DIM.Bo	DIM.Ko
3.5 X 4.5	3.8 ± 0.1	4.8 ± 0.1	0.9 ± 0.1
3.0 X 3.0	3.3 ± 0.1	3.3 ± 0.1	0.9 ± 0.1
2.5 X 4.5	2.8 ± 0.1	4.8 ± 0.1	0.9 ± 0.1
2.5 X 3.5	2.8 ± 0.1	3.8 ± 0.1	0.9 ± 0.1
2.5 X 3.0	2.8 ± 0.1	3.3 ± 0.1	0.9 ± 0.1
2.5 X 2.5	2.8 ± 0.1	2.8 ± 0.1	0.9 ± 0.1

DIMENSIONS ARE IN MILLIMETERS

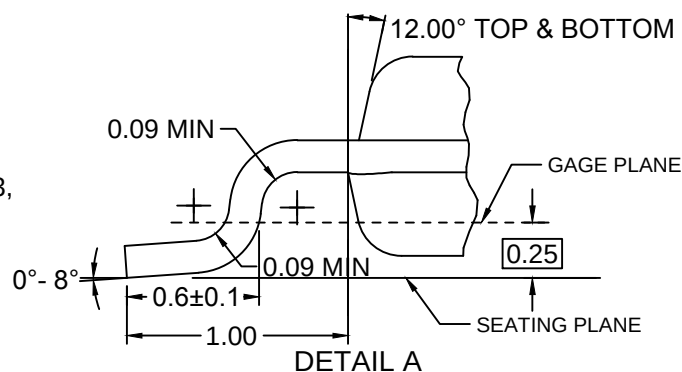
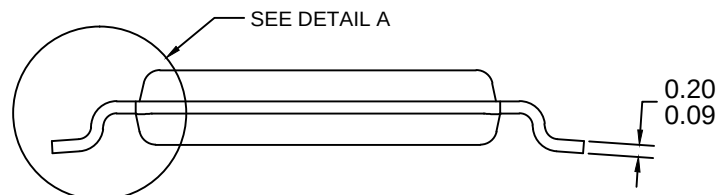
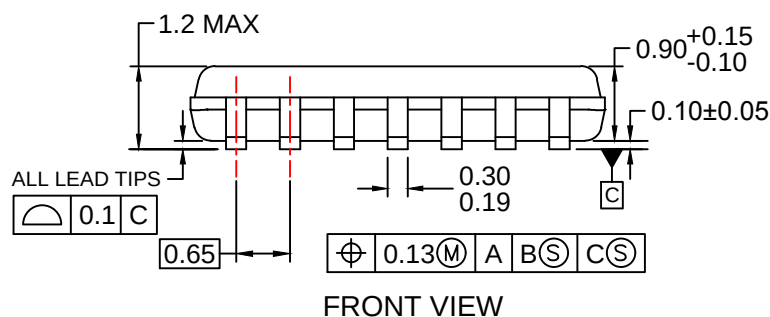
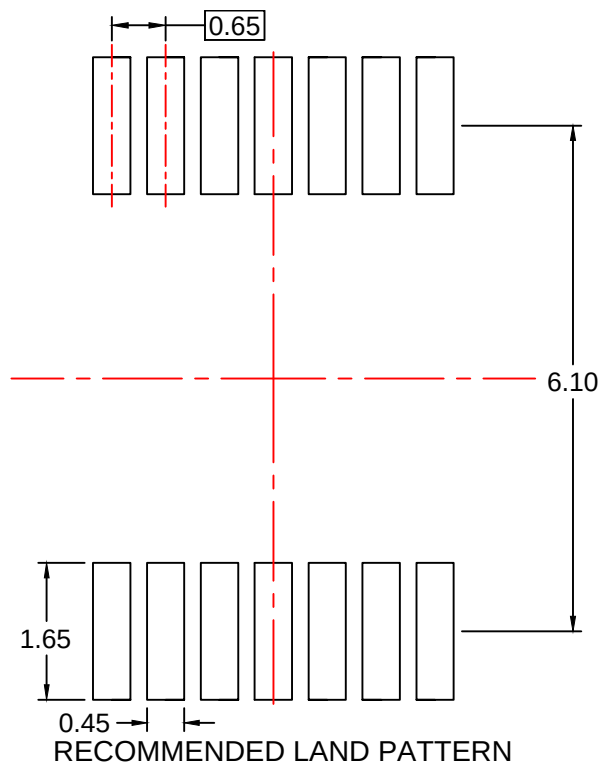
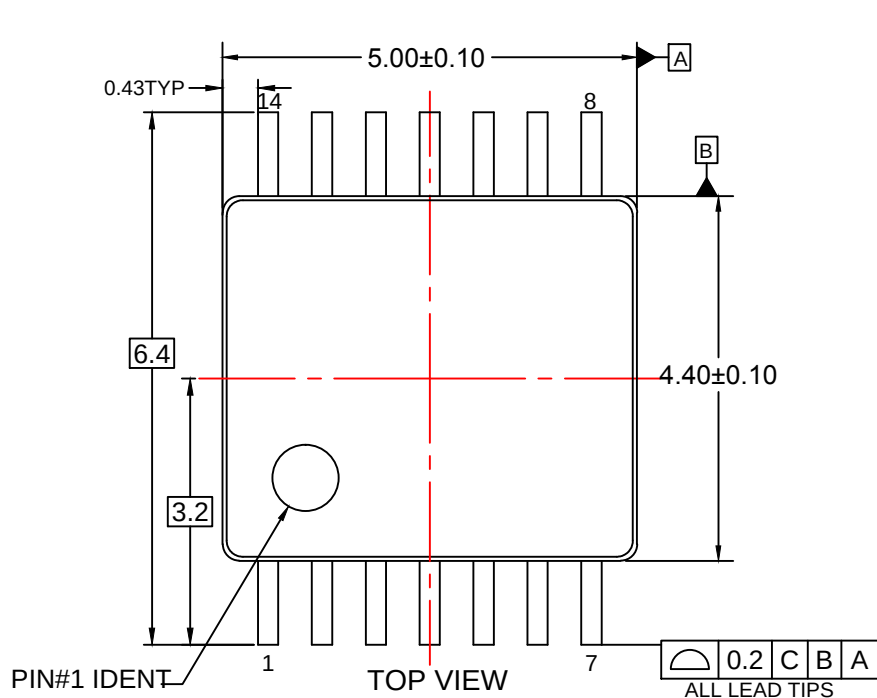
NOTES: unless otherwise specified

1. Cumulative pitch for feeding holes and cavities (chip pockets) not to exceed 0.008[0.20] over 10 pitch span.
2. Smallest allowable bending radius.
3. Thru hole inside cavity is centered within cavity.
4. Tolerance is ± 0.002 [0.05] for these dimensions on all 12mm tapes.
5. Ao and Bo measured on a plane 0.120[0.30] above the bottom of the pocket.
6. Ko measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
7. Pocket position relative to sprocket hole measured as true position of pocket. Not pocket hole.
8. Controlling dimension is millimeter. Dimension in inches rounded.

REEL DIMENSIONS inches (millimeters)



Tape Size	A	B	C	D	N	W1	W2
12 mm	13.0 (330)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	7.008 (178)	0.488 (12.4)	0.724 (18.4)



NOTES:

- CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AB, REF NOTE 6
- DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS
- DIMENSIONING AND TOLERANCES PER ANSI Y14.5M, 2009.
- LANDPATTERN STANDARD: SOP65P640X110-14M.
- DRAWING FILE NAME: MKT-MTC14rev7.



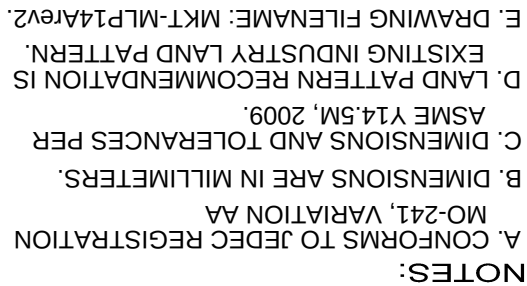
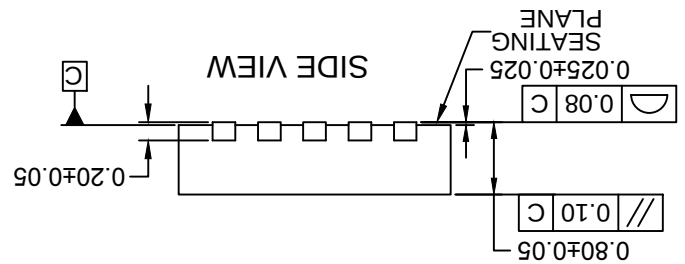


Figure 1 is a plan view of the test specimen, showing its dimensions and reinforcement layout. The specimen is rectangular with overall dimensions of 4.00 MAX (width) by 3.50 MAX (depth). The layout includes a central square area (1.40 MAX by 1.40 MAX) and surrounding rectangular areas. Reinforcement bars are numbered 1 through 14. Dimensions are given in meters (TYP).

Key dimensions and features include:

- Overall width: 4.00 MAX
- Overall depth: 3.50 MAX
- Central square area: 1.40 MAX by 1.40 MAX
- Reinforcement bars: 14 bars in total, numbered 1 through 14.
- Dimensions for reinforcement bars: 0.24 TYP, 0.50 TYP, 1.00, 1.70 MAX, 2.20 MAX, 2.40 MAX, 3.50 MAX, 4.00 MAX.
- Angles: (0.90) and 14.



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